BLA1011-300

Avionics LDMOS transistors

Rev. 3 — 1 September 2015

AMPLEON

Product data sheet

1. Product profile

1.1 General description

300 W LDMOS pulsed power transistor for TCAS and IFF applications at frequencies from 1030 MHz to 1090 MHz.

Table 1. Typical performance

RF performance at T_{case} = 25 °C in a common source class-AB production test circuit; t_p = 50 μs ; δ = 2 %.

Mode of operation	f	I _{Dq}	V _{DS}	PL	Gp	η_{D}
	(MHz)	(mA)	(V)	(W)	(dB)	(%)
Pulsed class-AB	1030 to 1090	150	32	300	16.5	57

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

1.2 Features

- Typical performance at frequencies between 1030 MHz and 1090 MHz, a supply voltage of 32 V, an I_{Dq} of 150 mA, a t_p of 50 μs and a δ of 2 %:
 - ◆ Output power = 300 W
 - ◆ Power gain = 16.5 dB (typ)
 - ◆ Efficiency = 57 % (typ)
- Easy power control
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for operation in 1030 MHz to 1090 MHz band
- Internally matched for ease of use
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

1.3 Applications

 RF power amplifiers for Avionics applications in the 1030 MHz to 1090 MHz frequency band

2. Pinning information

Table 2. Pinning

	3	
Pin	Description	Simplified outline Symbol
1	drain	
2	gate	
3	source	
		3 sym112
		37.11.12

^[1] Connected to flange

3. Ordering information

Table 3. Ordering information

Type number Package					
	Name	Description	Version		
BLA1011-300	-	flanged LDMOST ceramic package; 2 mounting holes; 2 leads	SOT957A		

4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DS}	drain-source voltage		-	65	V
V_{GS}	gate-source voltage		-0.5	+15	V
I_D	drain current		-	15	А
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	200	°C

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Max	Unit
$Z_{th(j-h)}$	transient thermal impedance from junction to heatsink	T_{case} = 25 °C; t_p = 50 μ s; δ = 2 %; P_L = 300 W	0.1	0.15	K/W

6. Characteristics

Table 6. Characteristics

 $T_i = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
$V_{(BR)DSS}$	drain-source breakdown voltage	$V_{GS} = 0 \text{ V}; I_D = 3.75 \text{ mA}$	65	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	$V_{DS} = 20 \text{ V}; I_D = 375 \text{ mA}$	5.2	5.6	6.2	V
V_{GSq}	gate-source quiescent voltage	$V_{DS} = 32 \text{ V}; I_D = 150 \text{ mA}$	-	5.48	-	V
I _{DSS}	drain leakage current	$V_{GS} = 0 \text{ V}; V_{DS} = 32 \text{ V}$	-	-	3.3	μΑ
I _{DSX}	drain cut-off current	$V_{GS} = V_{GS(th)} + 6 \text{ V}; V_{DS} = 10 \text{ V}$	50	63	73	Α
I _{GSS}	gate leakage current	$V_{GS} = 13 \text{ V}; V_{DS} = 0 \text{ V}$	-	-	60	nA
9 _{fs}	forward transconductance	$V_{DS} = 20 \text{ V}; I_D = 24 \text{ A}$	-	15	-	S
R _{DS(on)}	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 6 \text{ V}; I_D = 13.5 \text{ A}$	-	55	80	mΩ

7. Application information

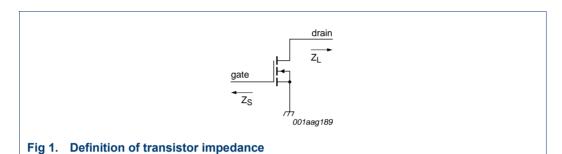
Table 7. Application information

Mode of operation: Pulsed RF; t_p = 50 μ s; δ = 2 %; V_{DS} = 32 V; I_{Dq} = 150 mA; T_{case} = 25 °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
P_{L}	output power		300	-	-	W
G_p	power gain	$P_{L} = 300 \text{ W}$	15	16.5	-	dB
RLin	input return loss	$P_{L} = 300 \text{ W}$	-	10	-	dB
η_{D}	drain efficiency	$P_{L} = 300 \text{ W}$	52	57	-	%
t _r	rise time	$P_{L} = 300 \text{ W}$	-	30	50	ns
t _f	fall time	$P_{L} = 300 \text{ W}$	-	5	50	ns
$P_{droop(pulse)}$	pulse droop power	P _L = 300 W	-	0	0.2	dB

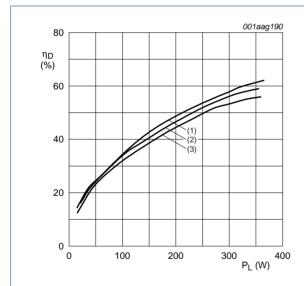
Table 8. Typical impedance

f	Z _S	Z _L
MHz	Ω	Ω
1030	4.25 – j3.57	1.27 – j0.33
1060	4.24 – j3.56	1.04 – j0.41
1090	4.47 – j3.71	0.91 – j0.60



7.1 Ruggedness in class-AB operation

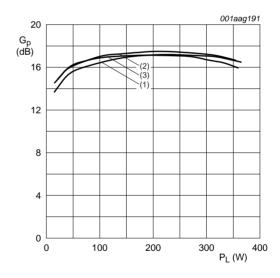
The BLA1011-300 is capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions: V_{DS} = 32 V; I_{Dq} = 150 mA; P_{L} = 300 W; f = 1030 MHz to 1090 MHz.



- (1) f = 1030 MHz
- (2) f = 1060 MHz
- (3) f = 1090 MHz

BLA1011-300 in a wideband circuit; V_{DS} = 32 V; I_{Dq} = 150 mA; t_p = 50 μ s; δ = 2 %.

Fig 2. Drain efficiency as functions of load power; typical values

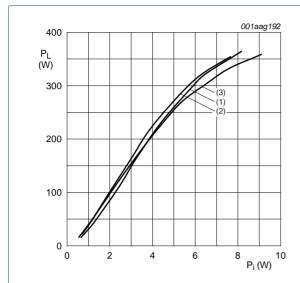


- (1) f = 1030 MHz
- (2) f = 1060 MHz
- (3) f = 1090 MHz

BLA1011-300 in a wideband circuit; V_{DS} = 32 V; I_{Dq} = 150 mA; t_p = 50 $\mu s;$ δ = 2 %.

Fig 3. Power gain as a function of load power; typical values

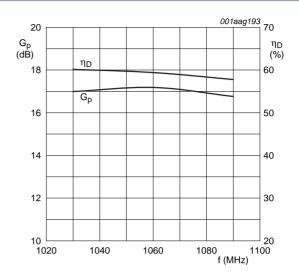
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- (1) f = 1030 MHz
- (2) f = 1060 MHz
- (3) f = 1090 MHz

BLA1011-300 in a wideband circuit; V_{DS} = 32 V; I_{Dq} = 150 mA; t_p = 50 μ s; δ = 2 %.

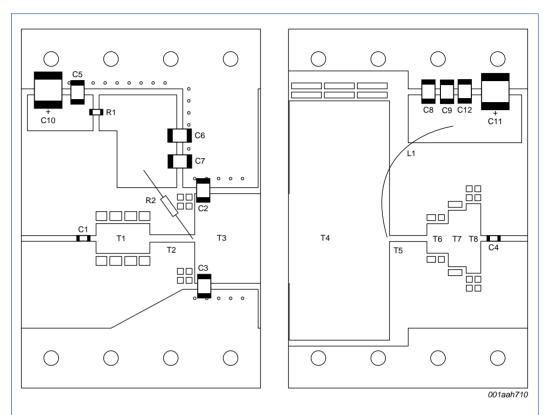
Fig 4. Load power as a function of input power; typical values



 V_{DS} = 32 V; I_{Dq} = 150 mA; t_p = 50 $\mu s; \, \delta$ = 2 %.

Fig 5. Power gain and drain efficiency as functions of frequency; typical values

8. Test information



Printed-Circuit Board (PCB): Rogers Duroid 6006; ε_r = 6.2 F/m; height = 0.64 mm. See Table 9 for list of components.

Fig 6. Component layout for common source class-AB pulsed production test circuit

Table 9. List of components (see Figure 6)

To ensure good power supply of the device, adding an electrolytic capacitor close to the supply connection of the circuit may be required. The actual capacitor value may differ depending on the pulse format, the quality of the power supply and the length of the connecting wires to the power supply. In general a value of 470 μ F will be sufficient.

Component	Description	Value	Remarks
C1, C4	multilayer ceramic chip capacitor	62 pF	[1]
C2, C3	multilayer ceramic chip capacitor	1.5 pF	[2]
C5	multilayer ceramic chip capacitor	100 pF	[2]
C6, C8	multilayer ceramic chip capacitor	62 pF	[2]
C7	multilayer ceramic chip capacitor	10 pF	[2]
C9	multilayer ceramic chip capacitor	1.2 nF	[1]
C10	electrolytic capacitor	47 μF; 20 V	
C11	electrolytic capacitor	47 μF; 63 V	
C12	multilayer ceramic chip capacitor	47 pF	[1]
L1	$\Omega\text{-shaped}$ enameled copper wire	d = 1 mm; length = 38 mm	
R1	SMD resistor	18 Ω	0508 package

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Table 9. List of components (see Figure 6) ... continued

To ensure good power supply of the device, adding an electrolytic capacitor close to the supply connection of the circuit may be required. The actual capacitor value may differ depending on the pulse format, the quality of the power supply and the length of the connecting wires to the power supply. In general a value of 470 μ F will be sufficient.

Component	Description	Value	Remarks
R2	metal film resistor	49.9 Ω	
T1	stripline	-	(W \times L) 5 mm \times 9 mm
T2	stripline	-	(W \times L) 1.25 mm \times 7.5 mm
T3	stripline	-	(W \times L) 15 mm \times 11 mm
T4	stripline	-	(W \times L) 40 mm \times 16.8 mm
T5	stripline	-	(W \times L) 1 mm \times 6.25 mm
T6	stripline	-	(W \times L) 4.95 mm \times 3.55 mm
T7	stripline	-	(W \times L) 9.4 mm \times 3 mm
T8	stripline	-	(W \times L) 12 mm \times 2.45 mm

^[1] American Technical Ceramics type 100A or capacitor of same quality.

^[2] American Technical Ceramics type 100B or capacitor of same quality.

9. Package outline

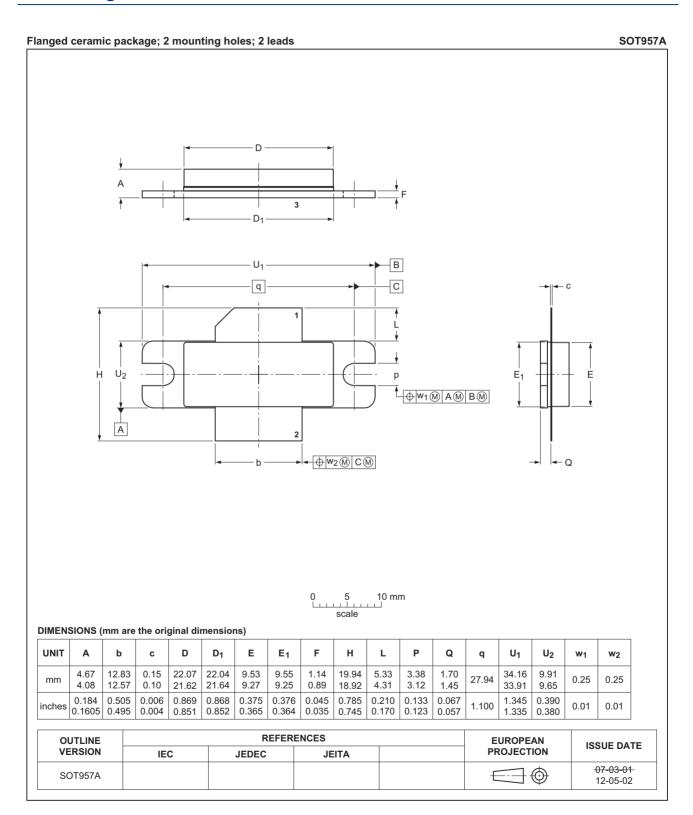


Fig 7. Package outline SOT957A

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10. Abbreviations

Table 10. Abbreviations

Acronym	Description
IFF	Identification Friend or Foe
LDMOS	Laterally Diffused Metal Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
RF	Radio Frequency
TCAS	Traffic Collision Avoidance System
VSWR	Voltage Standing-Wave Ratio

11. Revision history

Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLA1011-300#3	20150901	Product data sheet	-	BLA1011-300_2	
Modifications:	 The format of this document has been redesigned to comply with the new identity guidelines of Ampleon. Legal texts have been adapted to the new company name where appropriate. 				
BLA1011-300_2	20080205	Product data sheet	-	BLA1011-300_1	
BLA1011-300_1	20070403	Product data sheet	-	-	

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12.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions"
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